

LM4121 Precision Micropower Low Dropout Voltage Reference

Check for Samples: [LM4121](#)

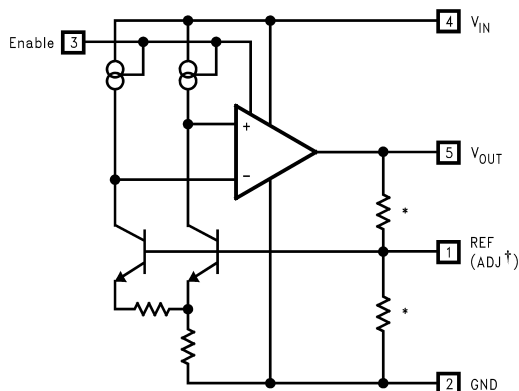
FEATURES (LM4121-1.2)

- Small SOT23-5 Package
- Low Voltage Operation
- High Output Voltage Accuracy: 0.2%
- Source and Sink Current Output: ± 5 mA
- Supply current: 160 μ A Typ.
- Low Temperature Coefficient: 50 ppm/ $^{\circ}$ C
- Enable Pin
- Output Voltages: 1.25V and Adjustable
- Industrial Temperature Range: -40° C to $+85^{\circ}$ C
- (For Extended Temperature Range, -40° C to $+125^{\circ}$ C, Contact Texas Instruments)

APPLICATIONS

- Portable, Battery Powered Equipment
- Instrumentation and Process Control
- Automotive & Industrial
- Test Equipment
- Data Acquisition Systems
- Precision Regulators
- Battery Chargers
- Base Stations
- Communications
- Medical Equipment

Block Diagram



* Resistors are removed on the LM4121-ADJ

†LM4121-ADJ only

Figure 1. LM4121-1.2 Block Diagram



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

Connection Diagrams

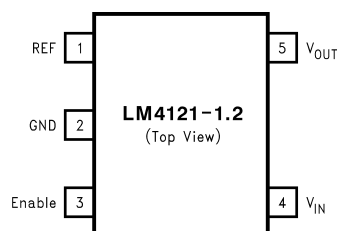


Figure 2. SOT23-5 Surface Mount Package

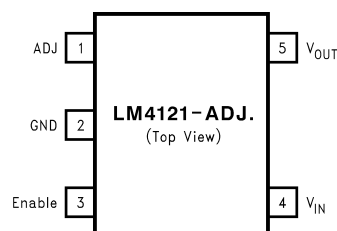


Figure 3. SOT23-5 Surface Mount Package

Table 1. SOT-23 Package Marking Information⁽¹⁾

Field Information
First Field:
R = Reference
Second and third Field:
19 = 1.250V Voltage Option
20 = Adjustable
Fourth Field:
A-B = Initial Reference Voltage Tolerance
A = $\pm 0.2\%$
B = $\pm 0.5\%$

(1) Only four fields of marking are possible on the SOT-23's small surface. This table gives the meaning of the four fields.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

Maximum Voltage on input or enable pins	-0.3V to 14V
Output Short-Circuit Duration	Indefinite
Power Dissipation ($T_A = 25^\circ\text{C}$) ⁽³⁾ :	
DBV0005B package - θ_{JA}	280°C/W
Power Dissipation	350 mW
ESD Susceptibility ⁽⁴⁾	
Human Body Model	2 kV
Machine Model	200V
Lead Temperature:	
Soldering, (10 sec.)	+260°C
Vapor Phase (60 sec.)	+215°C
Infrared (15 sec.)	+220°C

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see [Electrical Characteristics - LM4121-1.250V](#) and [Electrical Characteristics - LM4121-ADJ](#) tables. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Without PCB copper enhancements. The maximum power dissipation must be de-rated at elevated temperatures and is limited by T_{JMAX} (maximum junction temperature), θ_{JA} (junction to ambient thermal resistance) and T_A (ambient temperature). The maximum power dissipation at any temperature is: $P_{DissMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ up to the value listed in the [Absolute Maximum Ratings](#).
- (4) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

Operating Range ⁽¹⁾

Storage Temperature Range	–65°C to +150°C
Ambient Temperature Range	–40°C to +85°C
Junction Temperature Range	–40°C to +125°C

- (1) “Absolute Maximum Ratings” indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see [Electrical Characteristics - LM4121-1.250V](#) and [Electrical Characteristics - LM4121-ADJ](#) tables. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Electrical Characteristics LM4121-1.250V

Unless otherwise specified $V_{IN} = 3.3V$, $I_{LOAD} = 0$, $C_{OUT} = 0.01\mu F$, $T_A = T_J = 25^\circ C$. Limits with standard typeface are for $T_J = 25^\circ C$, and limits in **boldface type** apply over the $-40^\circ C \leq T_A \leq +85^\circ C$ temperature range.

Symbol	Parameter	Conditions	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
V_{OUT}	Output Voltage Initial Accuracy LM4121A-1.250			1.250	± 0.2	%
	LM4121-1.250				± 0.5	
$TCV_{OUT}/^\circ C$	Temperature Coefficient	$-40^\circ C \leq T_A \leq +125^\circ C$		14	50	ppm/ $^\circ C$
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$1.8V \leq V_{IN} \leq 12V$		0.0007	0.009 0.012	%/V
$\Delta V_{OUT}/\Delta I_{LOAD}$	Load Regulation	$0 mA \leq I_{LOAD} \leq 1 mA$		0.03	0.08 0.17	%/mA
		$1 mA \leq I_{LOAD} \leq 5 mA$		0.01	0.04 0.1	
		$-1 mA \leq I_{LOAD} \leq 0 mA$		0.04	0.12	
		$-5 mA \leq I_{LOAD} \leq -1 mA$		0.01		
Min- V_{IN}	Minimum Operating Voltage	$I_{LOAD} = 5mA$		1.5	1.8	V
V_N	Output Noise Voltage	0.1 Hz to 10 Hz		20		μV_{PP}
		10 Hz to 10 kHz		30		μV_{RMS}
I_S	Supply Current			160	250 275	μA
I_{SS}	Power-down Supply Current	$V_{IN} = 12V$ Enable = 0.4V Enable = 0.2V			1 2	μA
V_H	Logic High Input Voltage		1.6	1.5		V
V_L	Logic Low Input Voltage			0.4	0.2	V
I_H	Logic High Input Current			7	15	μA
I_L	Logic Low Input Current			0.1		μA
I_{SC}	Short Circuit Current	$V_{IN} = 3.3V$, $V_{OUT} = 0$		15		mA
			6		30	
		$V_{IN} = 12V$, $V_{OUT} = 0$		17		
			6		30	
Hyst	Thermal Hysteresis ⁽³⁾	$-40^\circ C \leq T_A \leq 125^\circ C$		0.5		mV/V

- (1) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate TI's Averaging Outgoing Quality Level (AOQL).

- (2) Typical numbers are at 25°C and represent the most likely parametric norm.

- (3) Thermal hysteresis is defined as the change in +25°C output voltage before and after exposing the device to temperature extremes.

Electrical Characteristics

LM4121-1.250V (continued)

Unless otherwise specified $V_{IN} = 3.3V$, $I_{LOAD} = 0$, $C_{OUT} = 0.01\mu F$, $T_A = T_j = 25^\circ C$. Limits with standard typeface are for $T_j = 25^\circ C$, and limits in **boldface type** apply over the $-40^\circ C \leq T_A \leq +85^\circ C$ temperature range.

Symbol	Parameter	Conditions	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
ΔV_{OUT}	Long Term Stability (4)	1000 hrs. @ $25^\circ C$		100		ppm

(4) Long term stability is change in V_{REF} at $25^\circ C$ measured continuously during 1000 hrs.

Electrical Characteristics

LM4121-ADJ

Unless otherwise specified $V_{IN} = 3.3V$, $V_{OUT} = V_{REF}$, $I_{LOAD} = 0$, $C_{OUT} = 0.01\mu F$, $T_A = T_j = 25^\circ C$. Limits with standard typeface are for $T_j = 25^\circ C$, and limits in **boldface type** apply over the $-40^\circ C \leq T_A \leq +85^\circ C$ temperature range.

Symbol	Parameter	Conditions	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
$V_{OUT} = V_{REF}$	Output Voltage Initial Accuracy LM4121A-ADJ			1.216	± 0.2	%
	LM4121-ADJ				± 0.5	
$TCV_{REF}/^\circ C$	Temperature Coefficient	$-40^\circ C \leq T_A \leq +125^\circ C$		14	50	ppm/ $^\circ C$
$\Delta V_{REF}/\Delta V_{IN}$	Line Regulation	$1.8V \leq V_{IN} \leq 12V$		0.0007	0.009 0.012	%/V
$\Delta V_{OUT}/\Delta I_{LOAD}$	Load Regulation	$0 mA \leq I_{LOAD} \leq 1 mA$		0.03	0.08 0.17	%/mA
		$1 mA \leq I_{LOAD} \leq 5 mA$		0.01	0.04 0.1	
		$-1 mA \leq I_{LOAD} \leq 0 mA$		0.04	0.12	
		$-5 mA \leq I_{LOAD} \leq -1 mA$		0.01		
Min- V_{IN}	Minimum Operating Voltage	$I_{LOAD} = 5 mA$		1.5	1.8	V
V_N	Output Noise Voltage (3)	0.1 Hz to 10 Hz		20		μV_{PP}
		10 Hz to 10 kHz		30		μV_{RMS}
I_S	Supply Current			160	250 275	μA
I_{SS}	Power-down Supply Current	$V_{IN} = 12V$ Enable = 0.4V Enable = 0.2V			1 2	μA
I_{BIAS}	Reference Pin Bias Current	(4)	15	40		nA
V_H	Logic High Input Voltage		1.6	1.5		V
V_L	Logic Low Input Voltage			0.4	0.2	V
I_H	Logic High Input Current			7	15	μA
I_L	Logic Low Input Current			0.1		μA
I_{SC}	Short Circuit Current	$V_{OUT} = 0$		15		mA
			6		30	
		$V_{IN} = 12V$, $V_{OUT} = 0$		17		
			6		30	

(1) Limits are 100% production tested at $25^\circ C$. Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate TI's Averaging Outgoing Quality Level (AOQL).

(2) Typical numbers are at $25^\circ C$ and represent the most likely parametric norm.

(3) Output noise for 1.25V option. Noise is proportional to V_{OUT} .

(4) Bias Current flows out of the Adjust pin.

Electrical Characteristics

LM4121-ADJ (continued)

Unless otherwise specified $V_{IN} = 3.3V$, $V_{OUT} = V_{REF}$, $I_{LOAD} = 0$, $C_{OUT} = 0.01\mu F$, $T_A = T_j = 25^\circ C$. Limits with standard typeface are for $T_j = 25^\circ C$, and limits in **boldface type** apply over the $-40^\circ C \leq T_A \leq +85^\circ C$ temperature range.

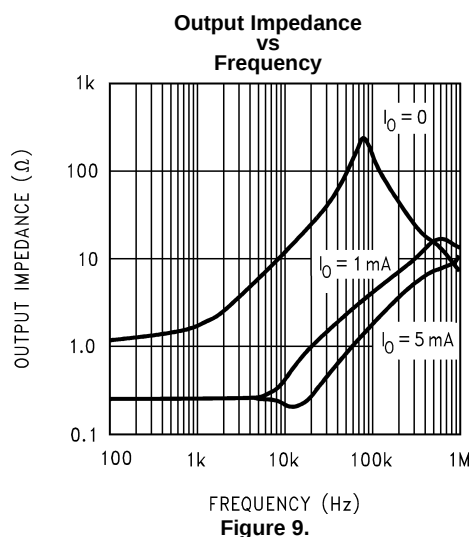
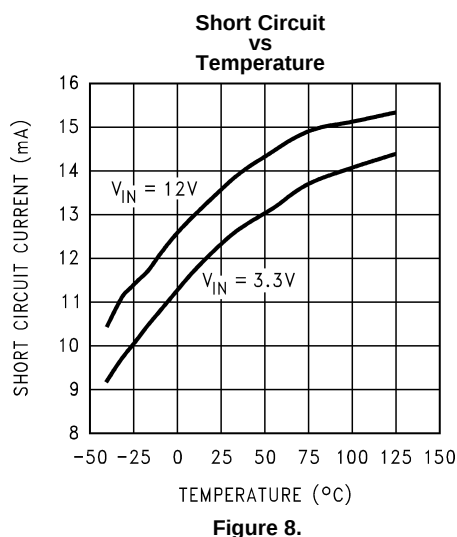
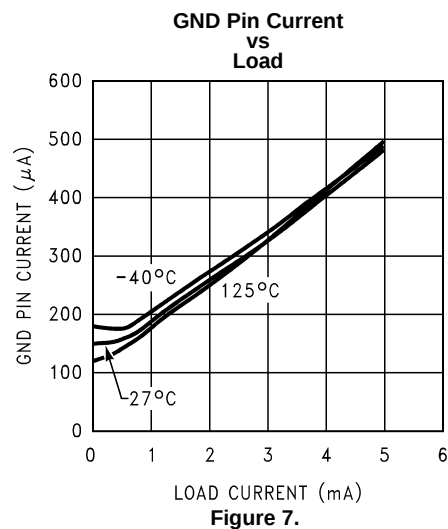
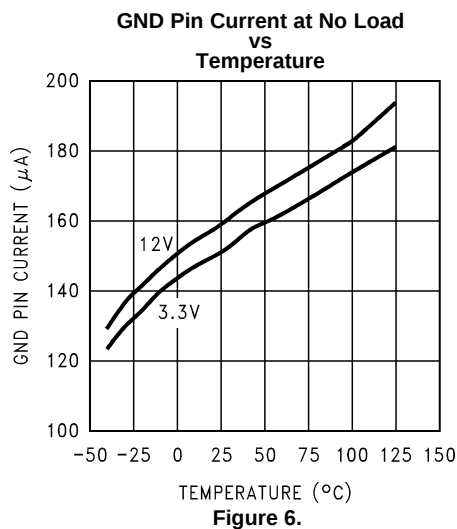
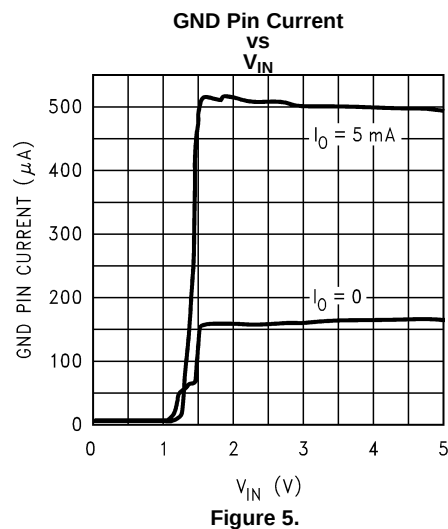
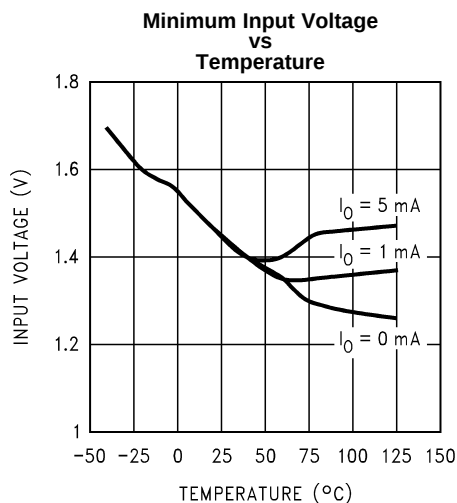
Symbol	Parameter	Conditions	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
Hyst	Thermal Hysteresis (5)	$-40^\circ C \leq T_A \leq 125^\circ C$		0.5		mV/V
ΔV_{OUT}	Long Term Stability (6)	1000 hrs. @ $25^\circ C$		100		ppm

(5) Thermal hysteresis is defined as the change in $+25^\circ C$ output voltage before and after exposing the device to temperature extremes.

(6) Long term stability is change in V_{REF} at $25^\circ C$ measured continuously during 1000 hrs.

LM4121- (All Options) Typical Operating Characteristics

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.25V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.



LM4121- (All Options) Typical Operating Characteristics (continued)

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.25V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.

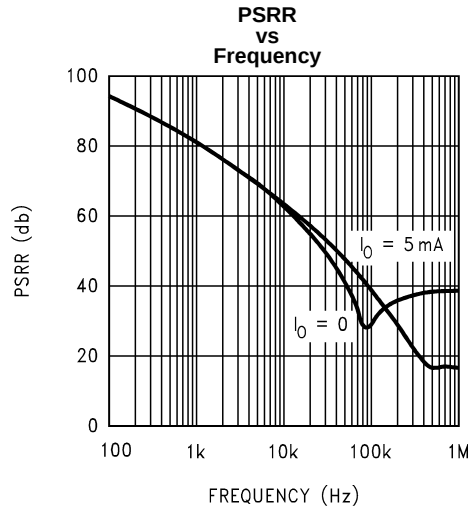


Figure 10.

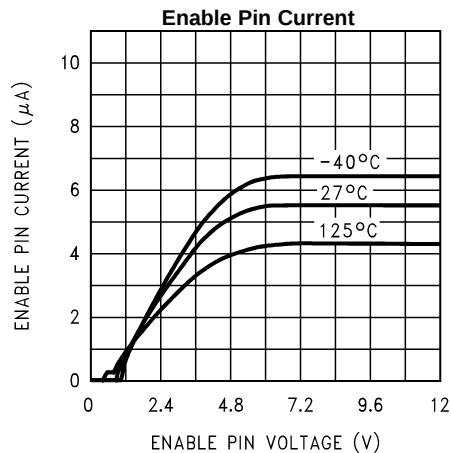


Figure 11.

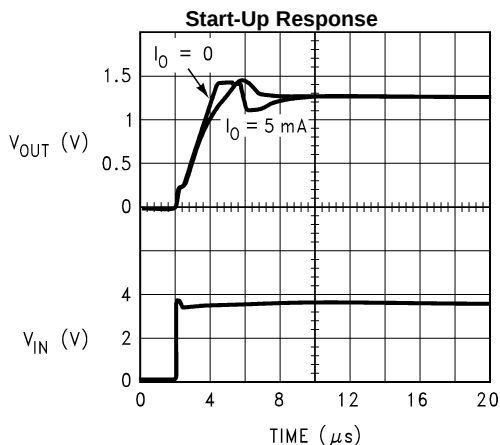


Figure 12.

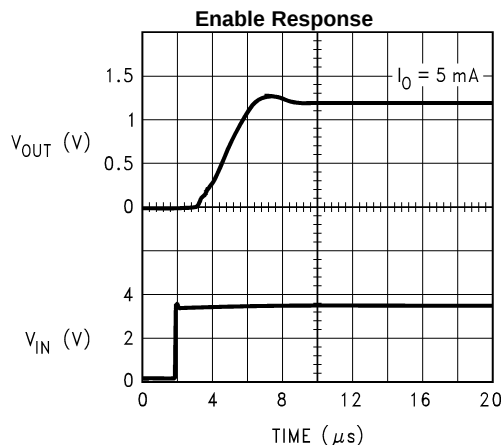


Figure 13.

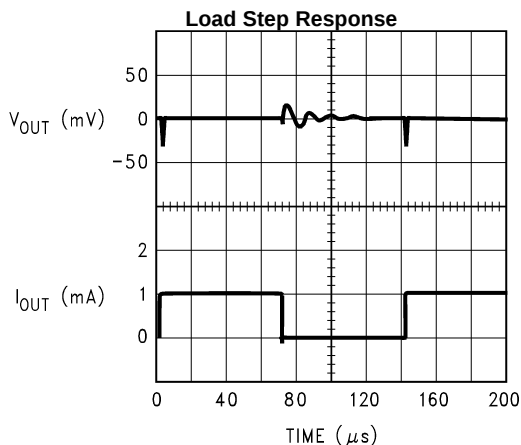


Figure 14.

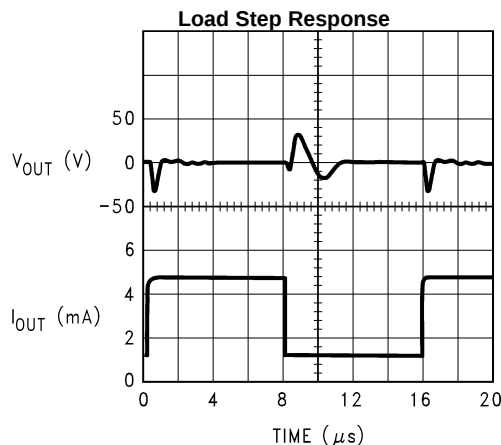


Figure 15.

LM4121- (All Options) Typical Operating Characteristics (continued)

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.25V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.

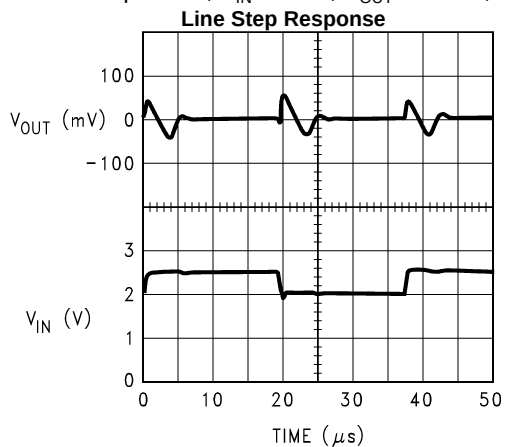


Figure 16.

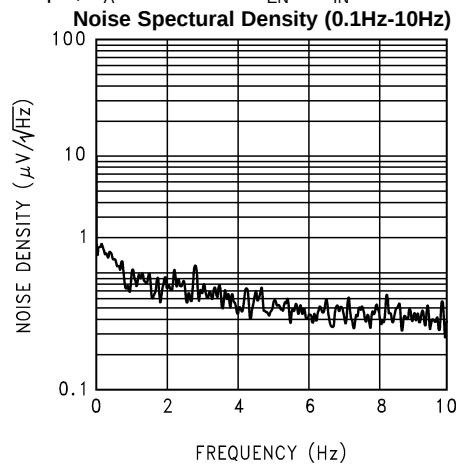


Figure 17.

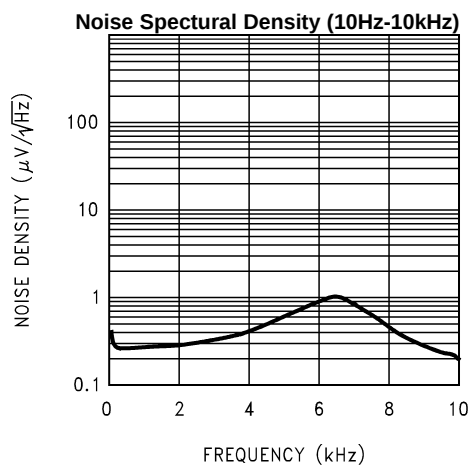


Figure 18.

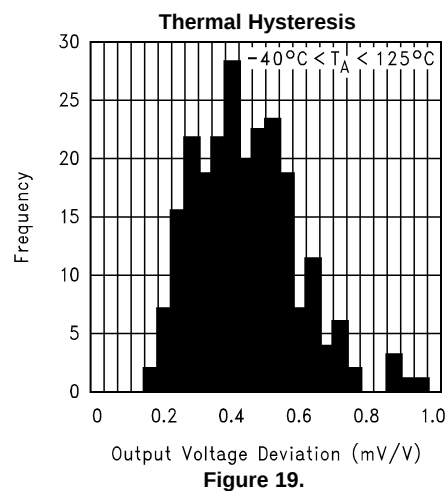


Figure 19.

LM4121-1.25 Typical Operating Characteristics

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.25V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.

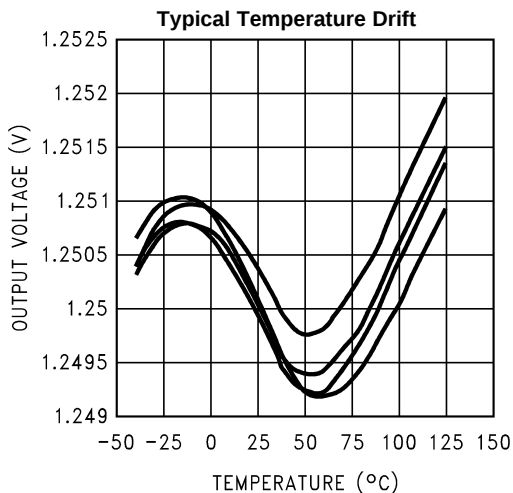


Figure 20.

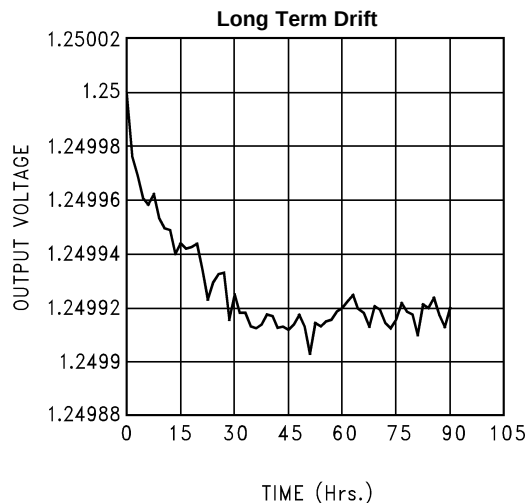


Figure 21.

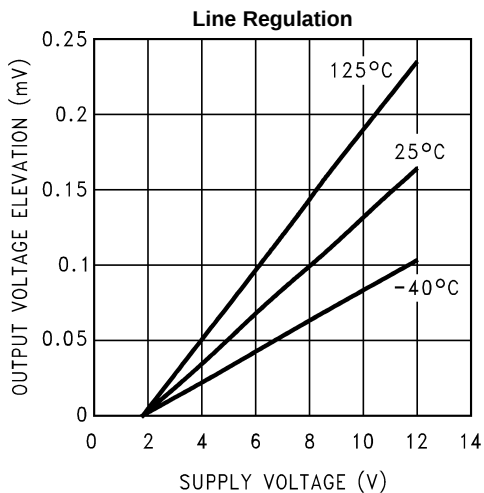


Figure 22.

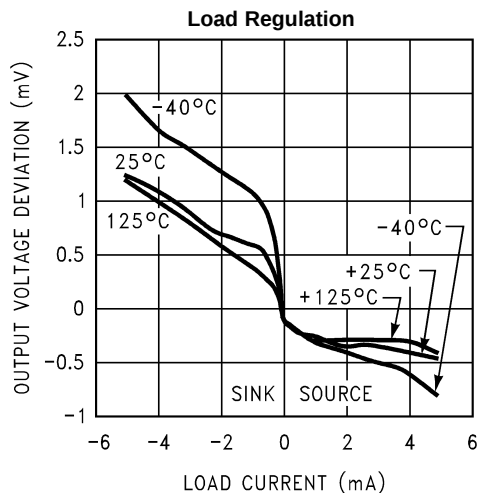


Figure 23.

LM4121-ADJ Typical Operating Characteristics

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.2V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.

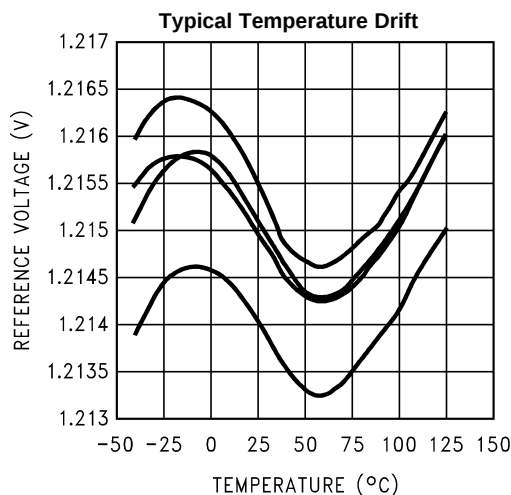


Figure 24.

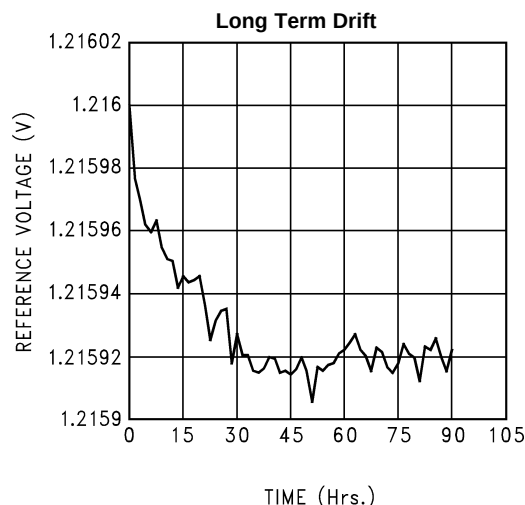


Figure 25.

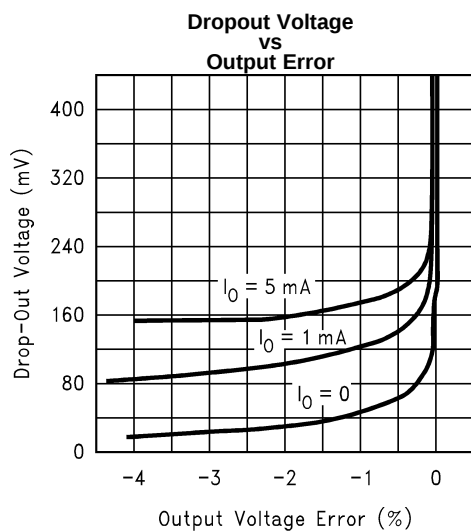


Figure 26.

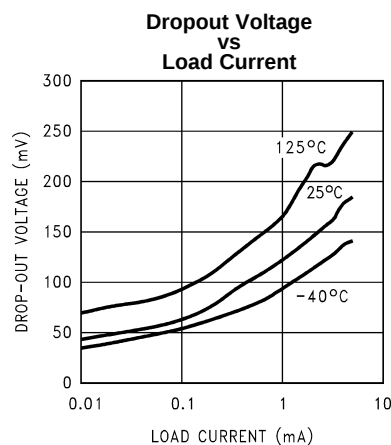


Figure 27.

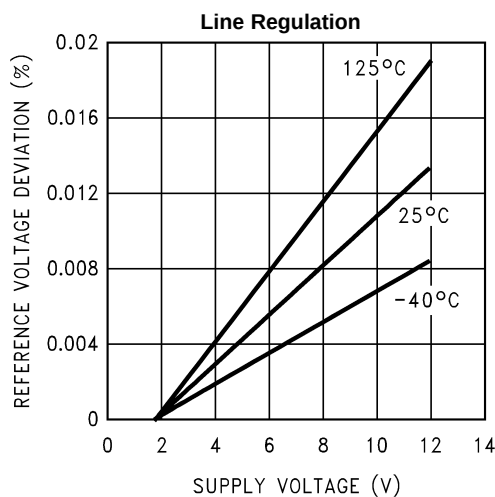


Figure 28.

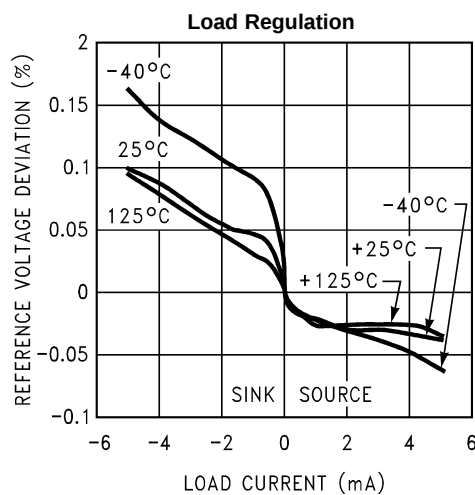


Figure 29.

LM4121-ADJ Typical Operating Characteristics (continued)

Unless otherwise specified, $V_{IN} = 3.3V$, $V_{OUT} = 1.2V$, $I_{LOAD} = 0$, $C_{OUT} = 0.022\mu F$, $T_A = 25^\circ C$ and $V_{EN} = V_{IN}$.

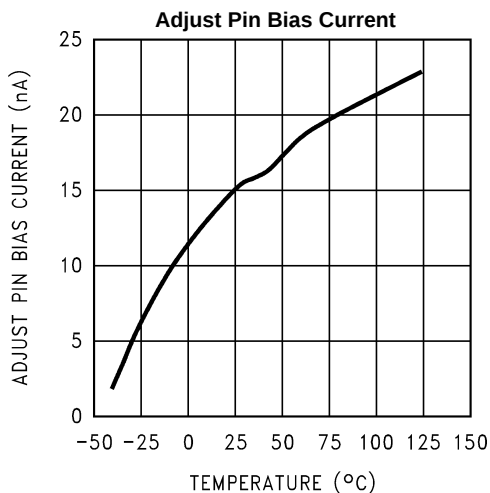


Figure 30.

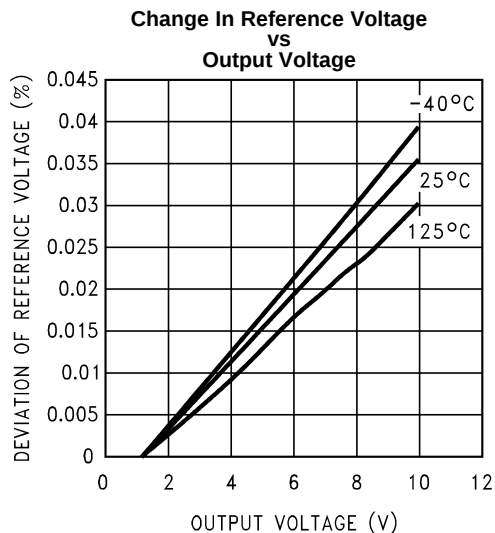


Figure 31.

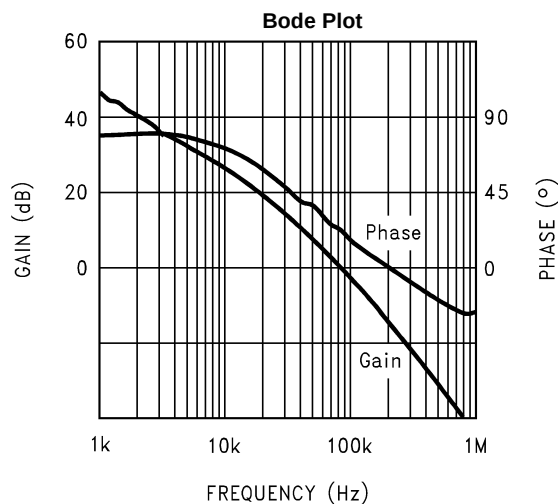


Figure 32.

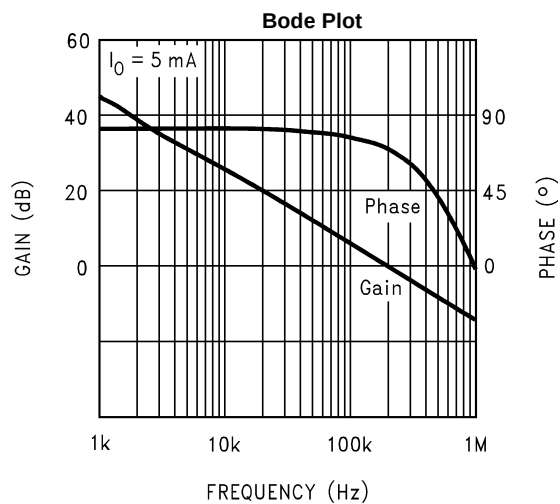


Figure 33.

PIN DESCRIPTIONS

Output (Pin 5)	Reference Output.
Input (Pin 4)	Positive Supply.
Ground (Pin 2)	Negative Supply or Ground Connection
Enable (Pin 3)	Pulled to input for normal operation. Forcing this pin to ground will turn-off the output.
REF (Pin 1)	REF Pin (1.25V option only). This pin should be left unconnected for 1.25V option.
Adj (Pin 1)	V _{OUT} Adj Pin (Adjustable option only). See Application Hints section.

APPLICATION HINTS

The standard application circuit for the LM4121 is shown in [Figure 34](#). The output voltage is set with the two feedback resistors, according to the following formula:

$$V_{OUT} = [V_{ref}(1 + R1/R2)] - I_{bias} \cdot R1 \quad (1)$$

Values for R1 and R2 should be chosen to be less than 1 MΩ. I_{bias} typically flows out of the adjust pin. Values for V_{ref} and I_{bias} are found in the [Electrical Characteristics - LM4121-1.250V](#) and [Electrical Characteristics - LM4121-ADJ](#) tables. For best accuracy, be sure to take into account the variation of V_{REF} with input voltage, load and output voltage.

The LM4121 is designed to be stable with ceramic output capacitors in the range of 0.022μF to 0.047μF. Note that 0.022μF is the minimum required output capacitor. These capacitors typically have an ESR of about 0.1 to 0.5Ω. Smaller ESR can be tolerated, however larger ESR can not. The output capacitor can be increased to improve load transient response, up to about 1μF. However, values above 0.047μF must be tantalum. With tantalum capacitors, in the 1μF range, a small capacitor between the output and the reference (Adj) pin is required. This capacitor will typically be in the 50pF range. Care must be taken when using output capacitors of 1μF or larger. These application must be thoroughly tested over temperature, line and load. Also, when the LM4121 is used as a controller, with external active components, each application must be carefully tested to ensure a stable design. The adjust pin is sensitive to noise and capacitive loading. The trace to this pin must be as short as possible and the feedback resistors should be close to this pin. Also, a single point ground to the LM4121 will help ensure good accuracy at high load currents.

An input capacitor is typically not required. However, a 0.1μF ceramic can be used to help prevent line transients from entering the LM4121. Larger input capacitors should be tantalum or aluminium.

The enable pin is an analog input with very little hysteresis. About 6μA into this pin is required to turn the part on, and it must be taken close to GND to turn the part off (see [Electrical Characteristics - LM4121-1.250V](#) and [Electrical Characteristics - LM4121-ADJ](#) tables for thresholds). There is a *minimum* slew rate on this pin of about 0.003V/μS to prevent glitches on the output. All of these conditions can easily be met with ordinary CMOS or TTL logic. If the shutdown feature is not required, then this pin can safely be connected directly to the input supply. Floating this pin is not recommended.

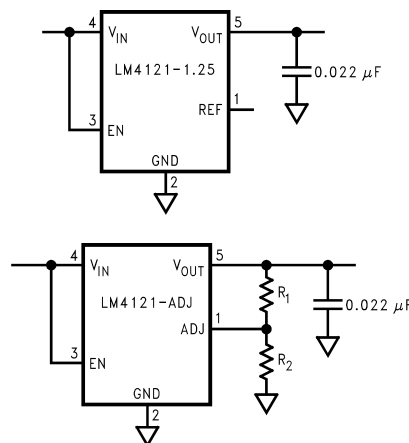


Figure 34. Standard Application Circuit

PRINTED CIRCUIT BOARD LAYOUT CONSIDERATION

The mechanical stress due to PC board mounting can cause the output voltage to shift from its initial value. References in SOT packages are generally less prone to assembly stress than devices in Small Outline (SOIC) package.

To reduce the stress-related output voltage shifts, mount the reference on the low flex areas of the PC board such as near to the edge or the corner of the PC board.

Typical Application Circuits

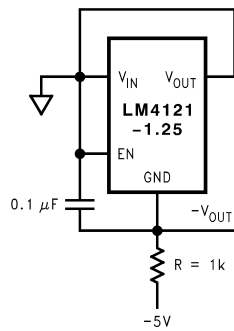


Figure 35. Voltage Reference with Negative Output

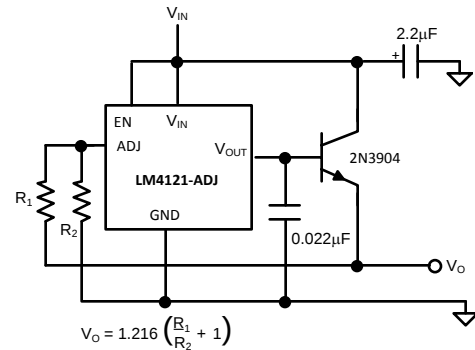


Figure 36. 100mA Quasi-LDO Regulator

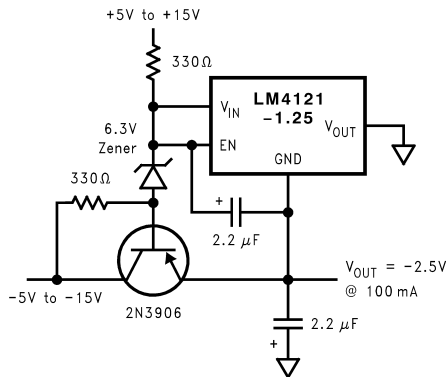


Figure 37. Boosted Output Current with Negative Voltage Reference

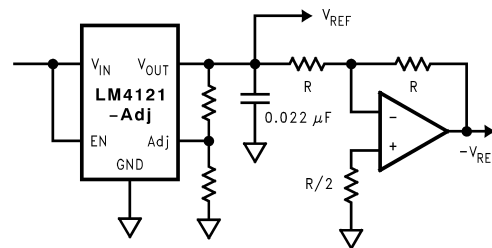


Figure 38. Voltage Reference with Complimentary Output

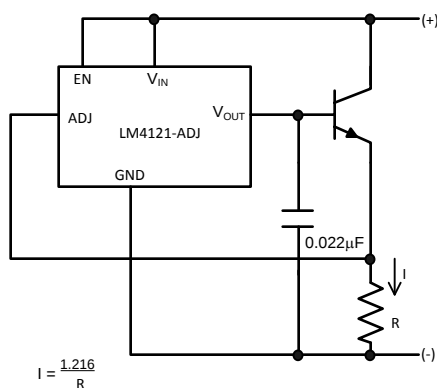


Figure 39. Two Terminal Constant Current Source

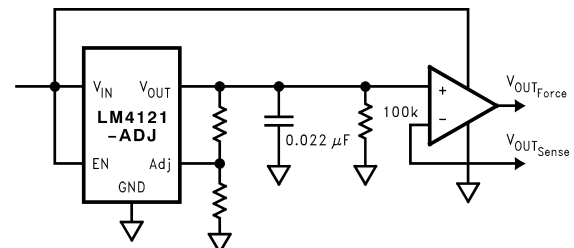


Figure 40. Precision Voltage Reference with Force and Sense Output

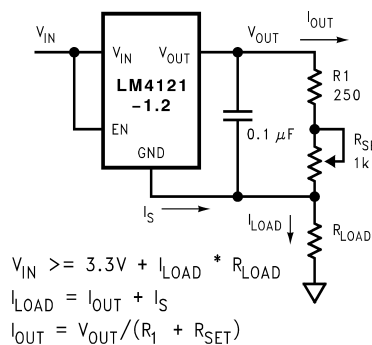


Figure 41. Programmable Current Source

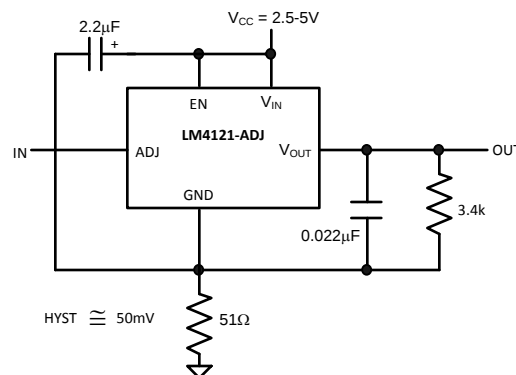


Figure 42. Precision Comparator with Hysteresis

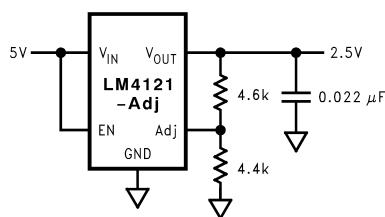


Figure 43. Power Supply Splitter

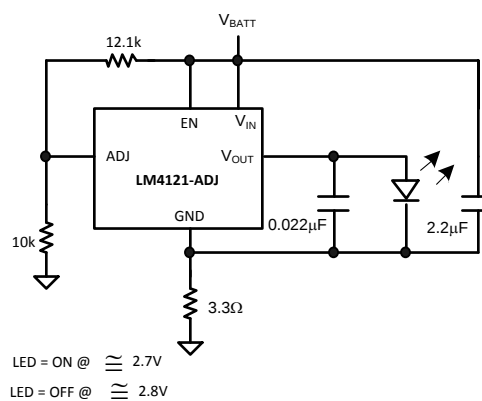


Figure 44. Li + Low Battery Detector

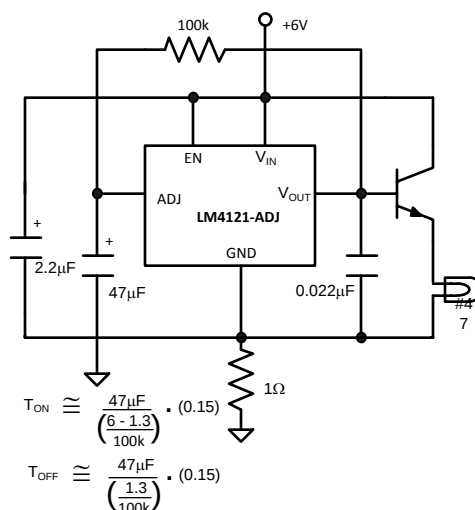


Figure 45. Flasher Circuit

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format	14

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM4121AIM5-1.2/NOPB	Obsolete	Production	SOT-23 (DBV) 5	-	-	Call TI	Call TI	-40 to 85	R19A
LM4121AIM5-ADJ/NOPB	Active	Production	SOT-23 (DBV) 5	1000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	R20A
LM4121AIM5X-ADJ/NOPB	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	R20A
LM4121IM5-1.2/NOPB	Obsolete	Production	SOT-23 (DBV) 5	-	-	Call TI	Call TI	-40 to 85	R19B
LM4121IM5-ADJ/NOPB	Active	Production	SOT-23 (DBV) 5	1000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	R20B
LM4121IM5-ADJ/NOPB.B	Active	Production	SOT-23 (DBV) 5	1000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	R20B
LM4121IM5X-ADJ/NOPB	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	R20B

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4121AIM5-ADJ/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LM4121AIM5X-ADJ/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LM4121IM5-ADJ/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LM4121IM5X-ADJ/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4121AIM5-ADJ/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
LM4121AIM5X-ADJ/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0
LM4121IM5-ADJ/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
LM4121IM5X-ADJ/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0



SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



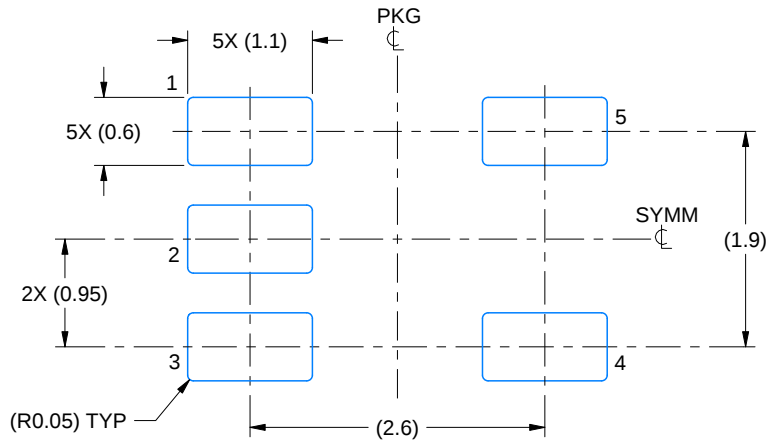
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

EXAMPLE BOARD LAYOUT

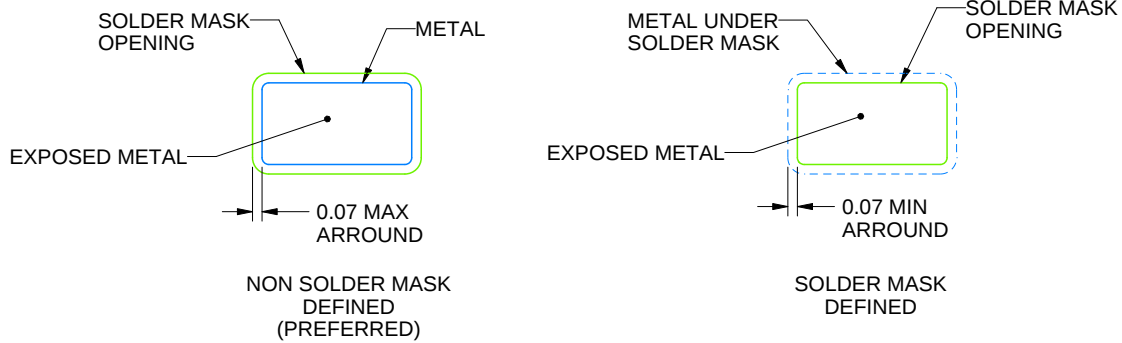
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

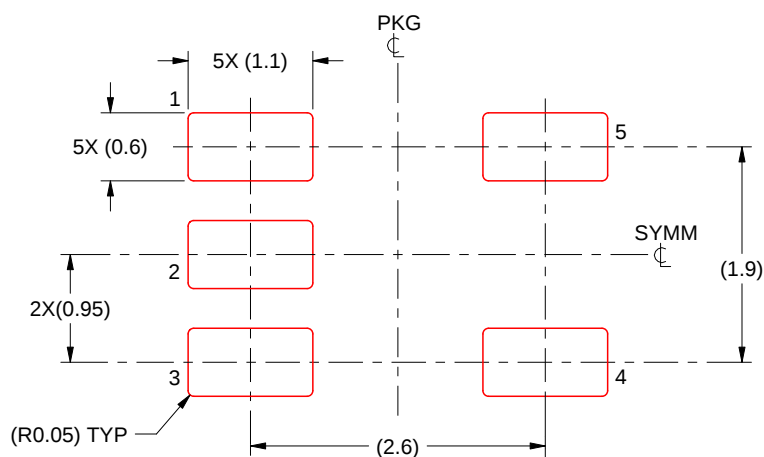
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2025, Texas Instruments Incorporated